

NCP700

200 mA, Ultra Low Noise, High PSRR, BiCMOS RF LDO Regulator

Noise sensitive RF applications such as Power Amplifiers in cell phones and precision instrumentation require very clean power supplies.

The NCP700 is 200 mA LDO that provides the engineer with a very stable, accurate voltage with ultra low noise and very high Power Supply Rejection Ratio (PSRR) suitable for RF applications. In order to optimize performance for battery operated portable applications, the NCP700 employs an advanced BiCMOS process to combine the benefits of low noise and superior dynamic performance of bipolar elements with very low ground current consumption at full loads offered by CMOS.

Furthermore, in order to provide a small footprint for space-conscious applications, the NCP700 is stable with small, low value capacitors and is available in a very small DFN6 2x2.2 package.

Features

- Output Voltage Options:
 - 1.8 V, 2.5 V, 2.75 V, 2.8 V, 3.0 V, 3.3 V
 - Contact Factory for Other Voltage Options
- Output Current Limit 200 mA
- Ultra Low Noise (typ 15 μV_{rms})
- Very High PSRR (typ 80 dB)
- Stable with Ceramic Output Capacitors as low as 1 μF
- Low Sleep Mode Current (max 1 μA)
- Active Discharge Circuit
- Current Limit Protection
- Thermal Shutdown Protection
- These are Pb-Free Devices

Typical Applications

- Cellular Telephones (Power Amplifier)
- Noise Sensitive Applications (Video, Audio)
- Analog Power Supplies
- PDAs / Palmtops / Organizers / GPS
- Battery Supplied Devices

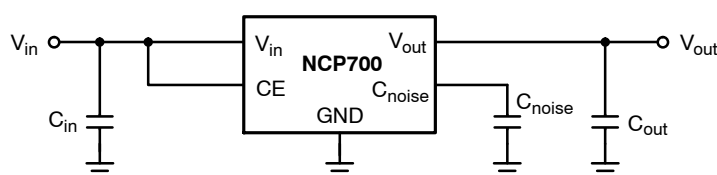
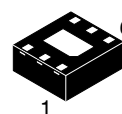


Figure 1. Typical Application Schematic



ON Semiconductor®

<http://onsemi.com>



6 PIN DFN, 2x2.2
MN SUFFIX
CASE 506BA

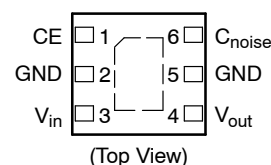
MARKING DIAGRAM



XX = Specific Device Code
M = Date Code
▪ = Pb-Free Package

(Note: Microdot may be in either location)

PIN ASSIGNMENT



ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 9 of this data sheet.

NCP700

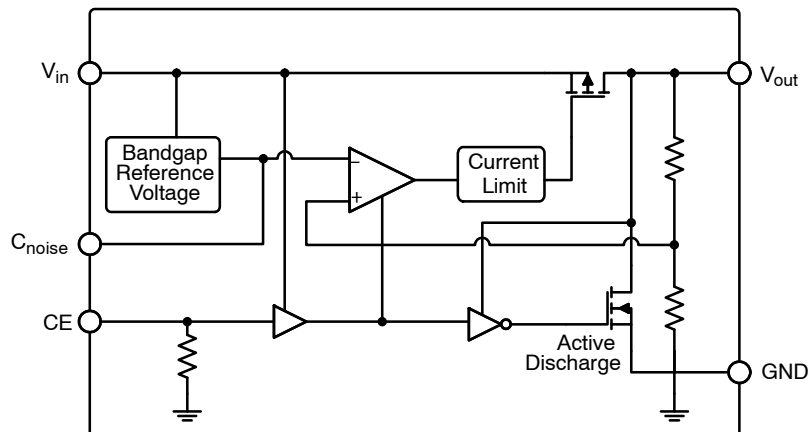


Figure 2. Simplified Block Diagram

PIN FUNCTION DESCRIPTION

DFN6 2x2.2 Pin No.	Pin Name	Description
1	CE	Chip Enable: This pin allows on/off control of the regulator. To disable the device, connect to GND. If this function is not in use, connect to V_{in} . Internal 5 M Ω Pull Down resistor is connected between CE and GND.
2, 5, EPAD	GND	Power Supply Ground (Pins are fused for the DFN package)
3	V_{in}	Power Supply Input Voltage
4	V_{out}	Regulated Output Voltage
6	C_{noise}	Noise reduction pin. (Connect 100 nF or 10 nF capacitor to GND)

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Input Voltage (Note 1)	V_{in}	-0.3 V to 6 V	V
Chip Enable Voltage	V_{CE}	-0.3 V to $V_{in} + 0.3$ V	V
Noise Reduction Voltage	$V_{C_{noise}}$	-0.3 V to $V_{in} + 0.3$ V	V
Output Voltage	V_{out}	-0.3 V to $V_{in} + 0.3$ V	V
Maximum Junction Temperature (Note 1)	$T_{J(max)}$	150	$^{\circ}$ C
Storage Temperature Range	T_{STG}	-55 to 150	$^{\circ}$ C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

NOTE: This device series contains ESD protection and exceeds the following tests:

Human Body Model 2000 V per MIL-STD-883, Method 3015
Machine Model Method 200 V

THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Package Thermal Resistance, DFN6: (Note 1) Junction-to-Lead (pin 2) Junction-to-Ambient	$R_{\theta JA}$	37 120	$^{\circ}$ C/W

1. Refer to ELECTRICAL CHARACTERISTICS and APPLICATION INFORMATION for Safe Operating Area

NCP700

ELECTRICAL CHARACTERISTICS

($V_{in} = V_{out} + 0.5\text{ V}$, $V_{CE} = 1.2\text{ V}$, $C_{in} = 0.1\ \mu\text{F}$, $C_{out} = 1\ \mu\text{F}$, $C_{noise} = 10\ \text{nF}$, $T_A = -40^\circ\text{C}$ to 85°C , unless otherwise specified (Note 2))

Characteristic	Test Conditions	Symbol	Min	Typ	Max	Unit
REGULATOR OUTPUT						
Input Voltage		V_{in}	2.5	–	5.5	V
Output Voltage (Note 3)	$V_{in} = (V_{out} + 0.5\text{ V})$ to 5.5 V $I_{out} = 1\text{ mA}$	V_{out}	1.764 2.450 2.695 2.744 2.940 3.234 (–2%)	– – – – – – –	1.836 2.550 2.805 2.856 3.060 3.366 (+2%)	V
Output Voltage (Note 3)	$V_{in} = (V_{out} + 0.5\text{ V})$ to 5.5 V $I_{out} = 1\text{ mA}$ to 200 mA	V_{out}	1.746 2.425 2.6675 2.716 2.910 3.201 (–3%)	– – – – – – –	1.854 2.575 2.8325 2.884 3.090 3.399 (+3%)	V
Power Supply Ripple Rejection	$V_{in} = V_{out} + 1.0\text{ V} + 0.5\text{ V}_{p-p}$ $I_{out} = 1\text{ mA}$ to 150 mA $C_{noise} = 100\text{ nF}$ f = 120 Hz f = 1 kHz f = 10 kHz	PSRR	– – –	80 80 65	– – –	dB
Line Regulation	$V_{in} = (V_{out} + 0.5\text{ V})$ to 5.5 V, $I_{out} = 1\text{ mA}$	Reg _{line}	–0.2	–	0.2	%/V
Load Regulation	$I_{out} = 1\text{ mA}$ to 200 mA	Reg _{load}	–	12	25	mV
Output Noise Voltage	f = 10 Hz to 100 kHz $I_{out} = 1\text{ mA}$ to 150 mA $C_{noise} = 100\ \text{nF}$ $C_{noise} = 10\ \text{nF}$	V_n	– –	15 20	– –	μV_{rms}
Output Current Limit	$V_{out} = V_{out(nom)} - 0.1\text{ V}$	I_{LIM}	200	310	470	mA
Output Short Circuit Current	$V_{out} = 0\text{ V}$	I_{SC}	210	320	490	mA
Dropout Voltage (Note 4)	$I_{out} = 200\text{ mA}$	V_{DO}	– – – – –	170 150 150 140 130	215 205 205 200 200	mV

GENERAL

Ground Current	$I_{out} = 1\text{ mA}$ $I_{out} = 200\text{ mA}$	I_{GND}	– –	70 110	90 220	μA
Disable Current	$V_{CE} = 0\text{ V}$	I_{DIS}	–	0.1	1	μA
Thermal Shutdown Threshold (Note 5)		T_{SD}	–	150	–	$^\circ\text{C}$
Thermal Shutdown Hysteresis (Note 5)		T_{SH}	–	20	–	$^\circ\text{C}$

CHIP ENABLE

Input Threshold	Low High	$V_{th(CE)}$	– 1.2	– –	0.4 –	V
Internal Pull-Down Resistance (Note 6)		$R_{PD(CE)}$	2.5	5	10	$\text{M}\Omega$

TIMING

Turn-on Time	$I_{out} = 150\text{ mA}$ $C_{noise} = 10\ \text{nF}$ $C_{noise} = 100\ \text{nF}$	t_{on}	– –	0.4 4	– –	ms
Turn-off Time	$C_{noise} = 10\ \text{nF}/100\ \text{nF}$ $I_{out} = 1\text{ mA}$ $I_{out} = 10\text{ mA}$	t_{off}	– –	800 200	– –	μs

- Performance guaranteed over the indicated operating temperature range by design and/or characterization, production tested at $T_J = T_A = 25^\circ\text{C}$. Low duty cycle pulse techniques are used during testing to maintain the junction temperature as close to ambient as possible.
- Contact factory for other voltage options.
- Measured when output voltage falls 100 mV below the regulated voltage at $V_{in} = V_{out} + 0.5\text{ V}$ if $V_{out} < 2.5\text{ V}$, then $V_{DO} = V_{in} - V_{out}$ at $V_{in} = 2.5\text{ V}$.
- Guaranteed by design and characterization.
- Expected to disable device when CE pin is floating.

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TYPICAL CHARACTERISTICS

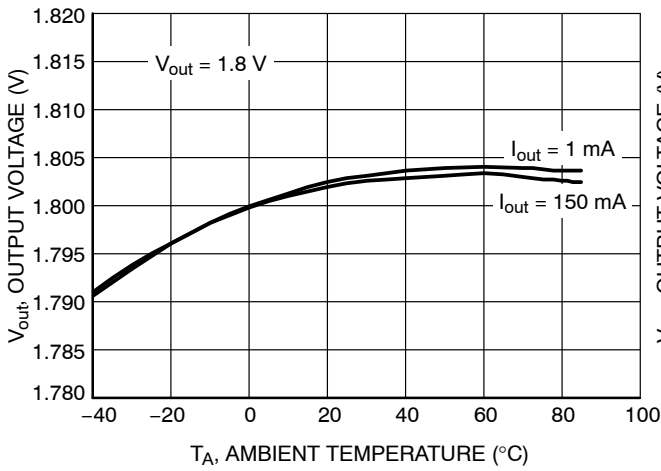


Figure 3. Output Voltage vs. Temperature
($V_{out} = 1.8 \text{ V}$)

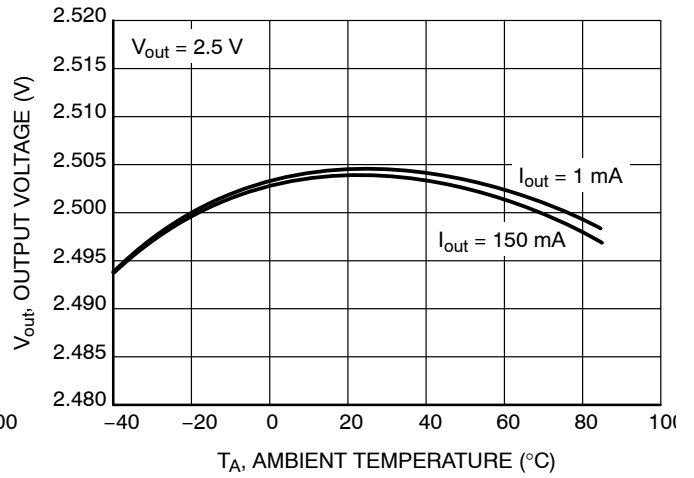


Figure 4. Output Voltage vs. Temperature
($V_{out} = 2.5 \text{ V}$)

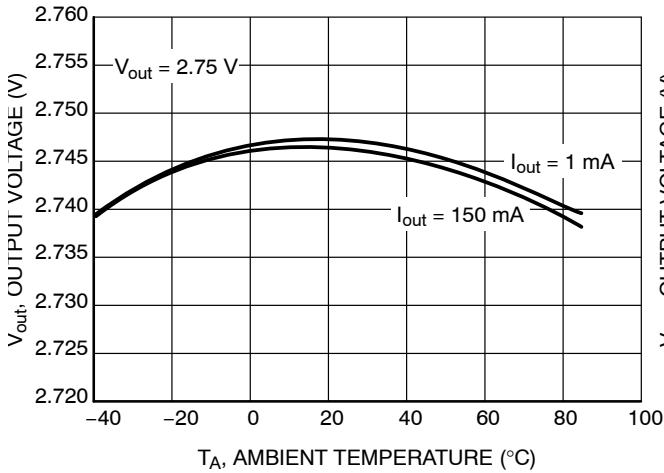


Figure 5. Output Voltage vs. Temperature
($V_{out} = 2.75 \text{ V}$)

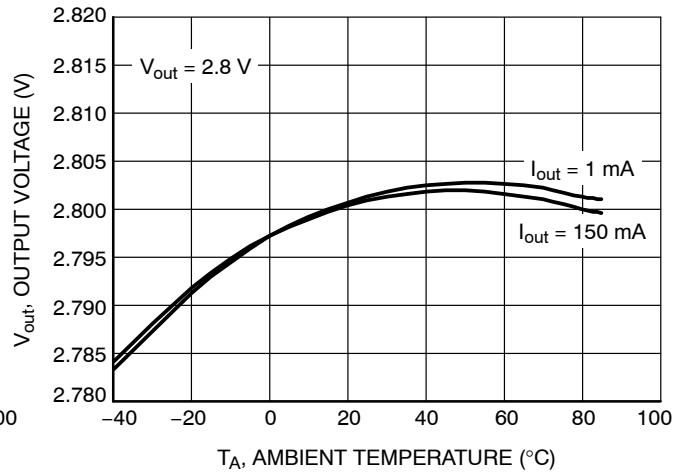


Figure 6. Output Voltage vs. Temperature
($V_{out} = 2.8 \text{ V}$)

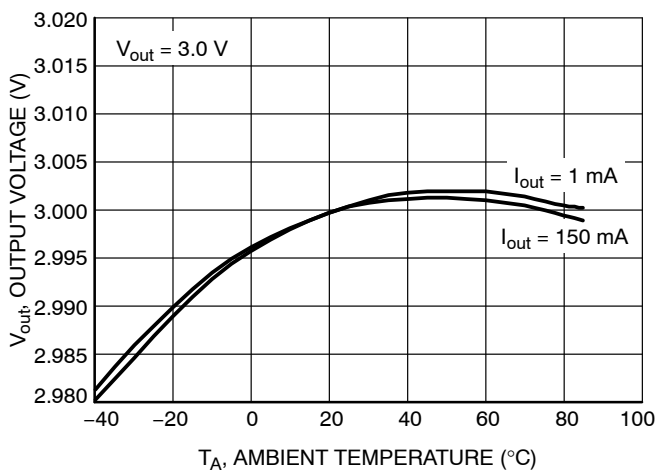


Figure 7. Output Voltage vs. Temperature
($V_{out} = 3.0 \text{ V}$)

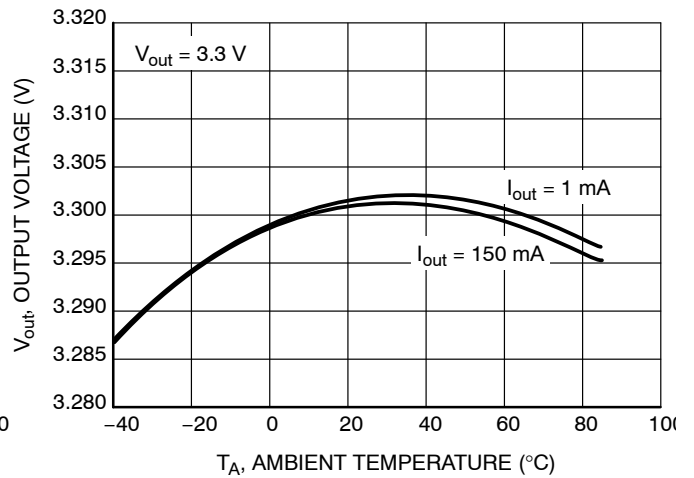


Figure 8. Output Voltage vs. Temperature
($V_{out} = 3.3 \text{ V}$)

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TYPICAL CHARACTERISTICS

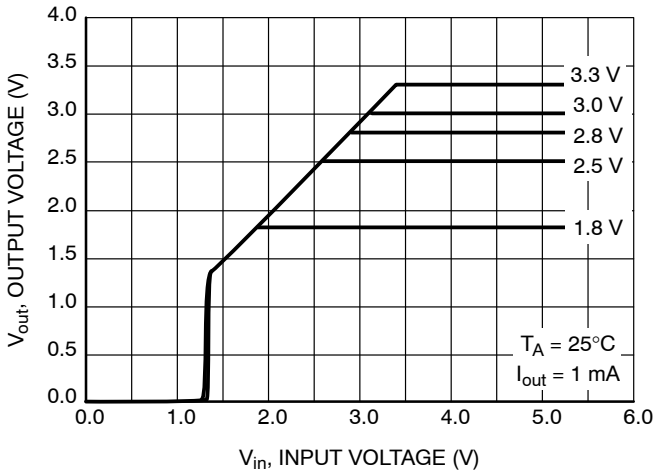


Figure 9. Output Voltage vs. Input Voltage

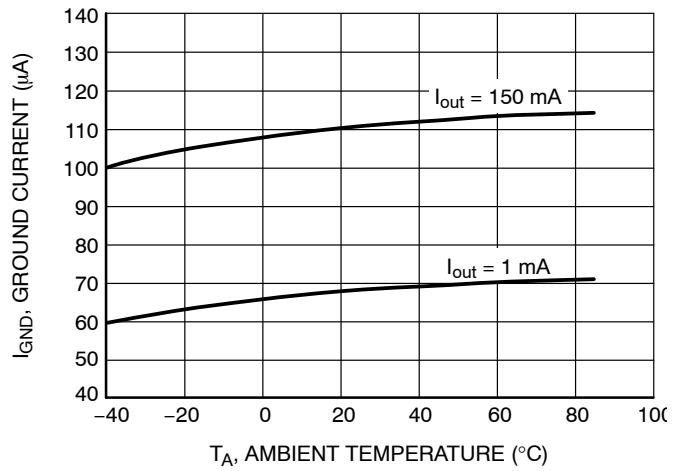


Figure 10. Ground Current vs. Temperature

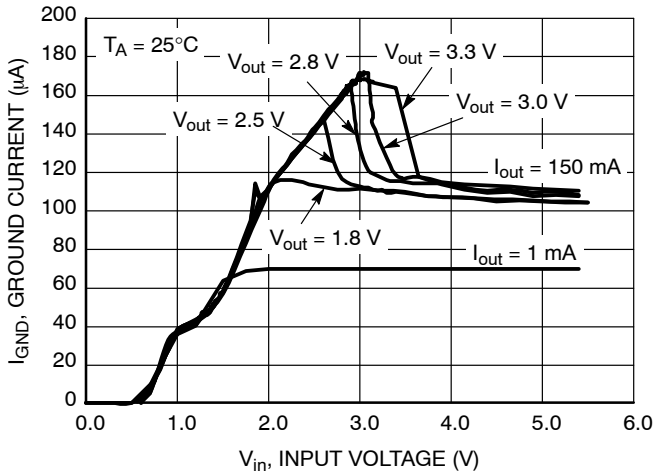


Figure 11. Ground Current vs. Input Voltage

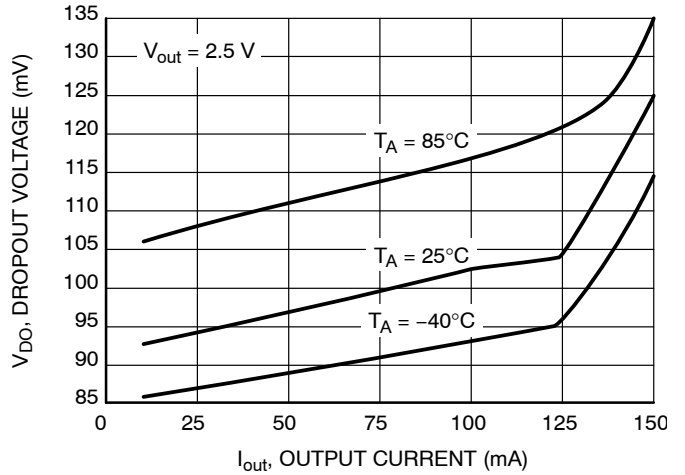


Figure 12. Dropout Voltage vs. Output Current

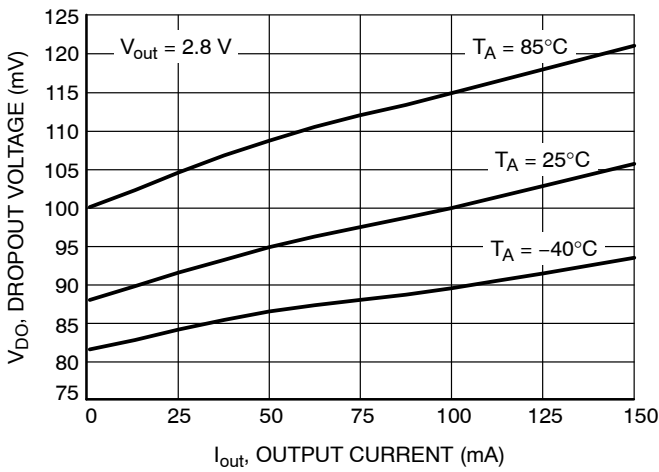


Figure 13. Dropout Voltage vs. Output Current

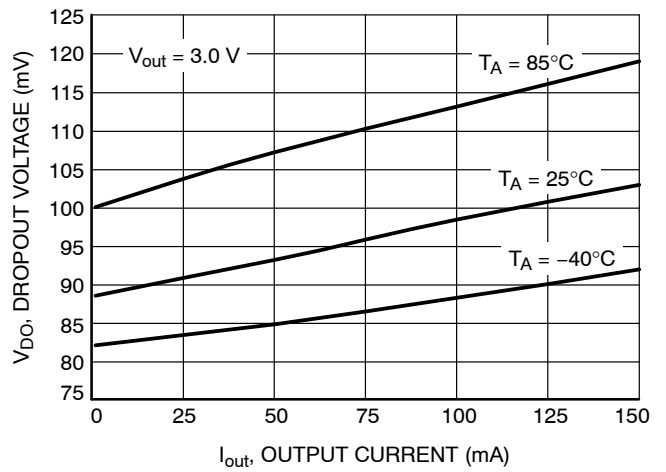


Figure 14. Dropout Voltage vs. Output Current

NCP700

TYPICAL CHARACTERISTICS

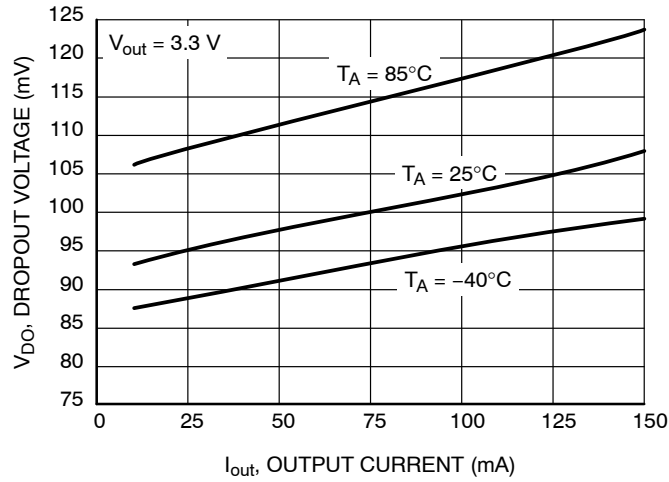


Figure 15. Dropout Voltage vs. Output Current

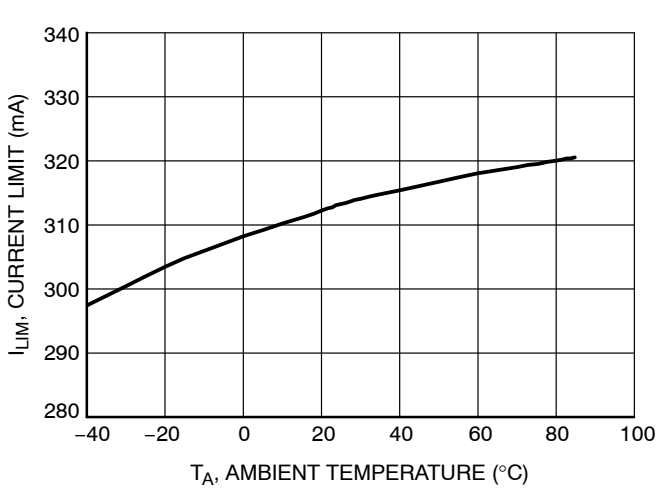


Figure 16. Current Limit vs. Temperature

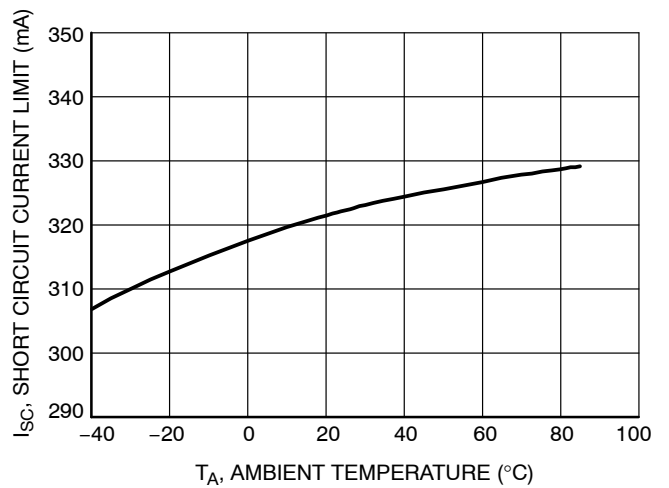


Figure 17. Short Circuit Current vs. Temperature

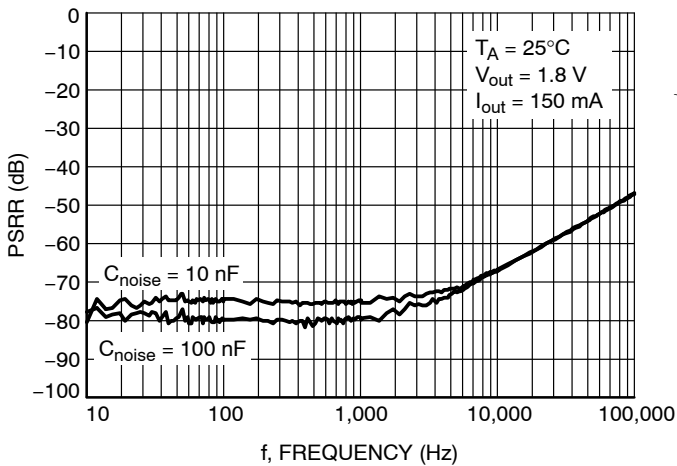


Figure 18. PSRR vs. Frequency

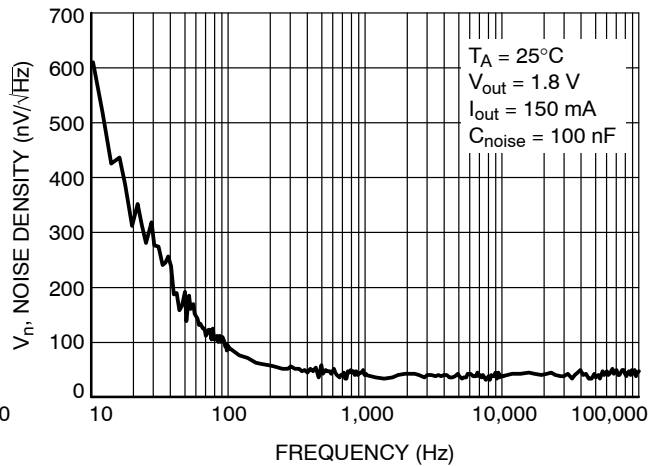
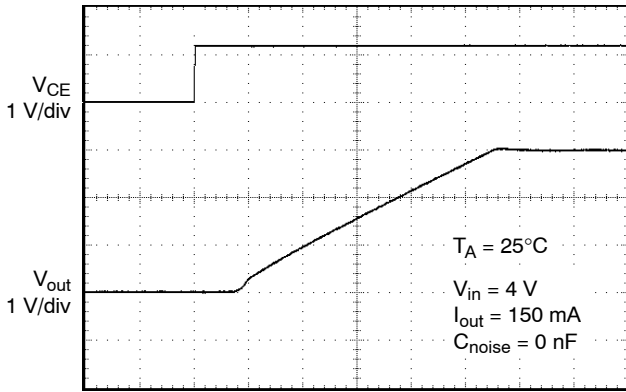


Figure 19. Noise Density vs. Frequency

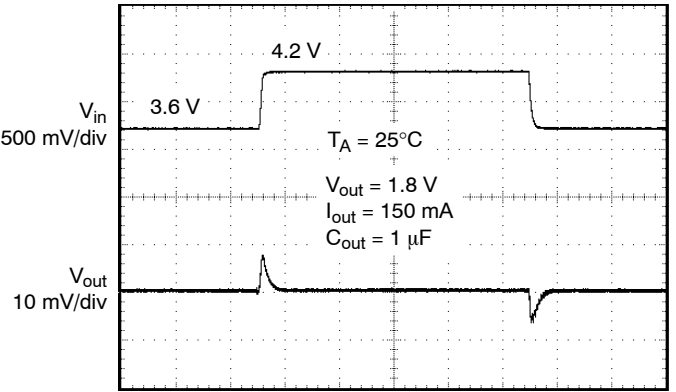
NCP700

TYPICAL CHARACTERISTICS



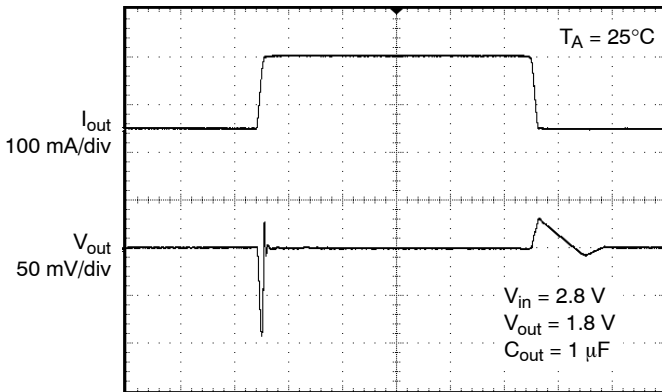
TIME (20 μ s/div)

Figure 20. Enable Voltage and Output Voltage vs. Time (Start-Up)



TIME (100 μ s/div)

Figure 21. Line Transient



TIME (40 μ s/div)

Figure 22. Load Transient

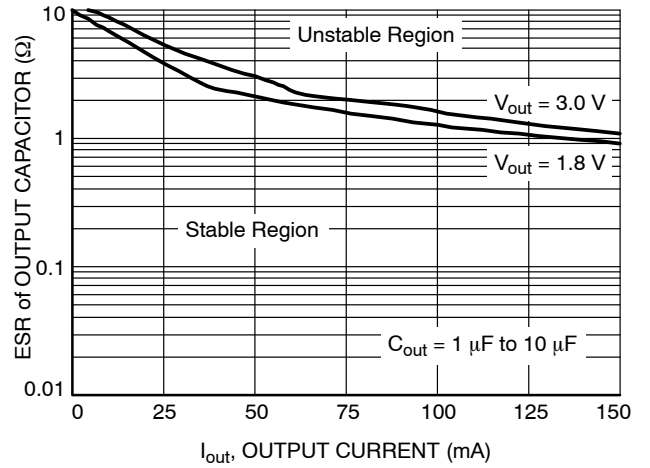


Figure 23. Output Capacitor ESR vs. Output Current

NCP700

APPLICATION INFORMATION

General

The NCP700 is a 200 mA (current limited) linear regulator with a logic input for on/off control for the high speed turn-off output voltage.

Access to the major contributor of noise within the integrated circuit is provided as the focus for noise reduction within the linear regulator system.

Power Up/Down

During power up, the NCP700 maintains a high impedance output (V_{out}) until sufficient voltage is present on V_{in} to power the internal bandgap reference voltage. When sufficient voltage is supplied (approx 1.2 V), V_{out} will start to turn on (assume CE shorted to V_{in}), linearly increasing until the output regulation voltage has been reached.

Active discharge circuitry has been implemented to insure a fast turn off time. Then CE goes low, the active discharge transistor turns on creating a fast discharge of the output voltage. Power to drive this circuitry is drawn from the output node. This is to maintain the lowest quiescent current when in the sleep mode ($V_{CE} = 0.4$ V). This circuitry subsequently turns off when the output voltage discharges.

CE (chip enable)

The enable function is controlled by the logic pin CE. The voltage threshold of this pin is set between 0.4 V and 1.2 V. A voltage lower than 0.4 V guarantees the device is off. A voltage higher than 1.2 V guarantees the device is on. The NCP700 enters a sleep mode when in the off state drawing less than 1 μ A of quiescent current.

The device can be used as a simple regulator without use of the chip enable feature by tying the CE pin to the V_{in} pin.

Current Limit

Output Current is internally limited within the IC to a minimum of 200 mA. The design is set to a higher value to allow for variation in processing and the temperature coefficient of the parameter. The NCP700 will source this amount of current measured with a voltage 100 mV lower than the typical operating output voltage.

The specification for short circuit current limit (@ $V_{out} = 0$ V) is specified at 320 mA (typ). There is no additional circuitry to lower the current limit at low output voltages. This number is provided for informational purposes only.

Output Capacitor

The NCP700 has been designed to work with low ESR ceramic capacitors. There is no ESR lower limit for stability for the recommended 1 μ F output capacitor. Stable region for Output capacitor ESR vs Output Current is shown in Figure 23.

Typical characteristics were measured with Murata ceramic capacitors. GRM219R71E105K (1 μ F, 25 V, X7R, 0805) and GRM21BR71A106K (10 μ F, 10 V, X7R, 0805).

Output Noise

The main contributor for noise present on the output pin V_{out} is the reference voltage node. This is because any noise which is generated at this node will be subsequently amplified through the error amplifier and the PMOS pass device. Access to the reference voltage node is supplied directly through the C_{noise} pin. Noise can be reduced from a typical value of 20 μ V_{rms} by using 10 nF to 15 μ V_{rms} by using a 100 nF from the C_{noise} pin to ground.

A bypass capacitor is recommended for good noise performance and better load transient response.

Thermal Shutdown

When the die temperature exceeds the Thermal Shutdown threshold, a Thermal Shutdown (TSD) event is detected and the output (V_{out}) is turned off. There is no effect from the active discharge circuitry. The IC will remain in this state until the die temperature moves below the shutdown threshold (150°C typical) minus the hysteresis factor (20°C typical).

This feature provides protection from a catastrophic device failure due to accidental overheating. It is not intended to be used as a substitute for proper heat sinking. The maximum device power dissipation can be calculated by:

$$P_D = \frac{T_J - T_A}{R_{\theta JA}}$$

Thermal resistance value versus copper area and package is shown in Figure 24.

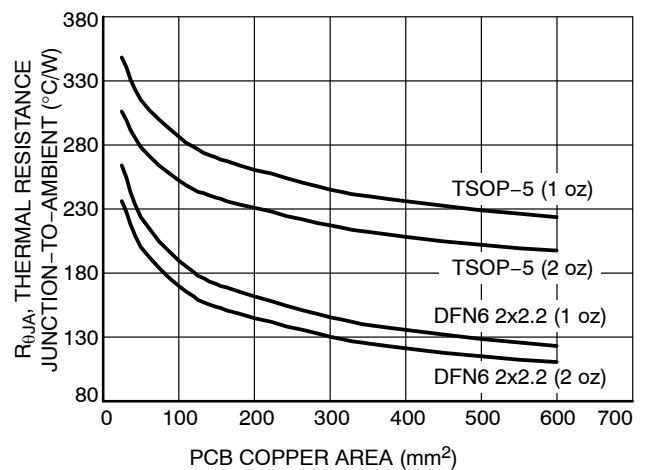


Figure 24. $R_{\theta JA}$ vs. PCB Copper Area

(TSOP-5 for comparison only)

NCP700

ORDERING INFORMATION

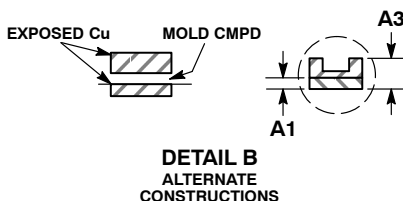
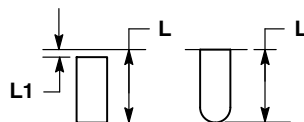
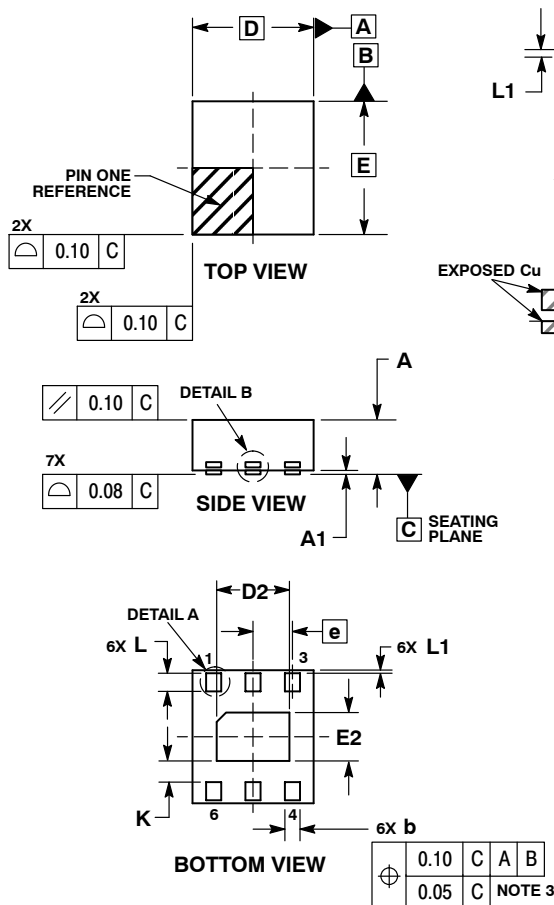
Device	Nominal Output Voltage	Marking	Package	Shipping†
NCP700MN180R2G	1.8 V	LZ	DFN6 2x2.2 (Pb-Free)	3000 / Tape & Reel
NCP700MN250R2G	2.5 V	LT		
NCP700MN275R2G	2.75 V	LU		
NCP700MN280R2G	2.8 V	LX		
NCP700MN300R2G	3.0 V	LY		
NCP700MN330R2G	3.3 V	LV		

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

NCP700

PACKAGE DIMENSIONS

6 PIN DFN, 2x2.2, 0.65P
CASE 506BA-01
ISSUE A

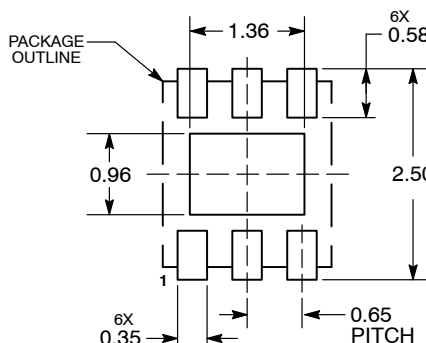


NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.20 mm FROM TERMINAL.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

MILLIMETERS		
DIM	MIN	MAX
A	0.80	1.00
A1	0.00	0.05
b	0.20	0.30
D	2.00 BSC	
D2	1.10	1.30
E	2.20 BSC	
E2	0.70	0.90
e	0.65 BSC	
K	0.20	---
L	0.25	0.35
L1	0.00	0.10

SOLDERING FOOTPRINT*



DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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